



AMENDMENT TRANSMITTAL LETTER

Docket No.
M4065.0226/P226

Application No.
09/484,437

Filing Date
January 18, 2000

Examiner
J. Mitchell

Art Unit
2827

Applicant(s): Tongbi Jiang

Invention: DIE ATTACH CURING METHOD FOR BGA PRODUCT

TO THE COMMISSIONER FOR PATENTS

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

CLAIMS AS AMENDED					
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	22	- 22 =		x	0.00
Independent Claims	2	- 3 =		x	0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT:					0.00

☒ Large Entity

☐ Small Entity

☒ No additional fee is required for this amendment.

☐ Please charge Deposit Account No. _____ in the amount of \$ _____.
A duplicate copy of this sheet is enclosed.

☐ A check in the amount of \$ _____ to cover the filing fee is enclosed.

☐ Payment by credit card. Form PTO-2038 is attached.

☒ The Commissioner is hereby authorized to charge and credit Deposit Account No. 04-1073 as described below. A duplicate copy of this sheet is enclosed.

☒ Credit any overpayment.

☒ Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.


Thomas J. D'Amico
Attorney Reg. No.: 28,371

Dated: February 5, 2003

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Docket No.: M4065.0226/P226
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Tongbi Jiang

Application No.: 09/484,437

Filed: January 18, 2000

For: DIE ATTACH CURING METHOD FOR
BGA PRODUCT

Group Art Unit: 2827

Examiner: J. Mitchell

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AMENDMENT

Box Non-Fee Amendment
Commissioner for Patents
Washington, DC 20231

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Dear Sir:

In response to the Office Action dated October 7, 2002, please amend the above-identified U.S. patent application as shown in the attached "Version With Markings to Show Changes Made."